General Purpose Transistor (-50V, -150mA)

## Datasheet

## **AEC-Q101 Qualified**

Parameter	Value
V <sub>CEO</sub>	-50V
Ic	-150mA

# SOT-346 SC-59

## Features

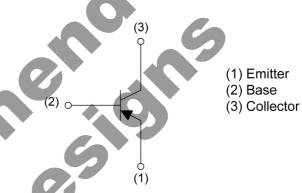
1)Excellent  $h_{\text{FE}}$  linearity.

2)Complements the 2SC2412K FRA.

# •Inner circuit

SMT3

Outline



# Application

GENERAL PURPOSE SMALL SIGNAL AMPLIFIER

# Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
2SA1037AK FRA	SOT-346 (SMT3)	2928	T146	180	8	3000	F

# ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

Parameter	Symbol	Values	Unit
Collector-base voltage	V <sub>CBO</sub>	-60	V
Collector-emitter voltage	V <sub>CEO</sub>	-50	V
Emitter-base voltage	V <sub>EBO</sub>	-6	V
Collector current	I <sub>C</sub>	-150	mA
Collector current	I <sub>CP</sub> *1	-200	mA
Power dissipation	P <sub>D</sub> *2	200	mW
Junction temperature	T <sub>j</sub>	150	လ
Range of storage temperature	T <sub>stg</sub>	-55 to +150	°C

# ● Electrical characteristics (T<sub>a</sub> = 25°C)

Parameter	Symbol	Conditions		Values		Unit
r alametei	Symbol	Conditions	Min.	Тур.	Max.	Offic
Collector-base breakdown voltage	BV <sub>CBO</sub>	I <sub>C</sub> = -50μA	-60	-	1	V
Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>C</sub> =-1mA	-50	ı	ı	٧
Emitter-base breakdown voltage	BV <sub>EBO</sub>	I <sub>E</sub> = -50μA	-6	1	1	٧
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = -60V	ı	1	-100	nA
Emitter cut-off current	T <sub>EBO</sub>	V <sub>EB</sub> = -6V	ı	1	-100	nA
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = -50 \text{mA}, I_B = -5 \text{mA}$	•	1	-500	mV
DC current gain	h <sub>FE</sub>	$V_{CE} = 6V, I_{C} = -1mA$	120	1	560	-
Transition frequency	fT	V <sub>CE</sub> = -12V, I <sub>E</sub> = 2mA, f = 100MHz	1	140	ı	MHz
Output capacitance	C <sub>ob</sub>	$V_{CB} = -12V, I_{E} = 0A,$ f = 1MHz	-	4.0	5.0	pF

# hFE values are calssified as follows:

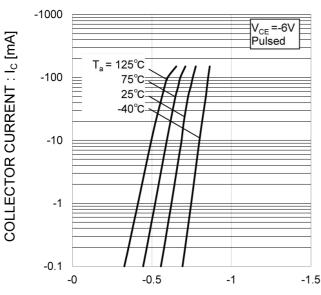
rank	Q	R	S	-	-
h <sub>FE</sub>	120-270	180-390	270-560	-	-

<sup>\*1</sup> Pw=1ms Single Pulse

<sup>\*2</sup> Each terminal mounted on a reference land

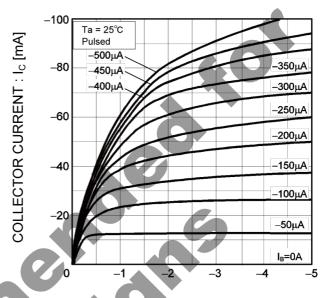
# ● Electrical characteristic curves(T<sub>a</sub> = 25°C)

Fig.1 Ground Emitter Propagation Characteristics



BASE TO EMITTER VOLTAGE: VBE [V]

Fig.2 Typical Output Characteristics



COLLECTOR TO EMITTER VOLTAGE :  $V_{\text{CE}}\left[V\right]$ 

Fig.3 DC Current Gain vs. Collector Current (I)

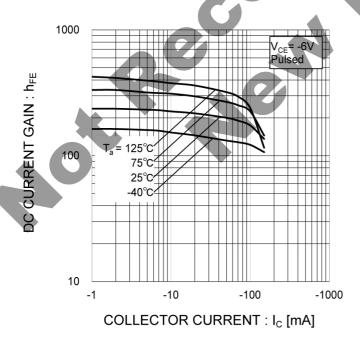
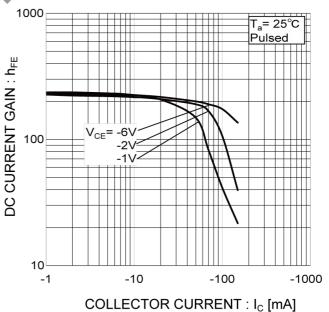


Fig.4 DC Current Gain vs. Collector Current (II)



# ● Electrical characteristic curves(T<sub>a</sub> = 25°C)

Fig.5 Collector-Emitter Saturation Voltage vs. Collector Current (I)

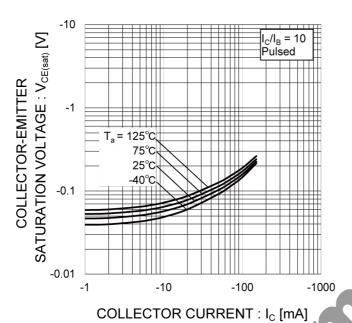
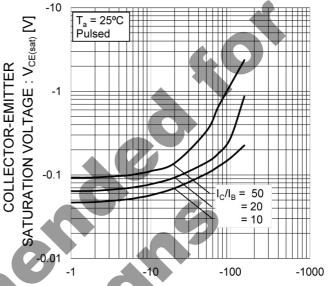


Fig.6 Collector-Emitter Saturation
Voltage vs. Collector Current (II)



COLLECTOR CURRENT : Ic [mA]

Fig.7 Base-Emitter Saturation Voltage vs. Collector Current

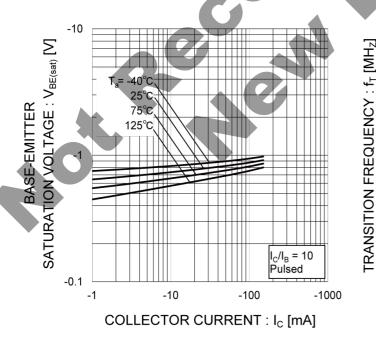
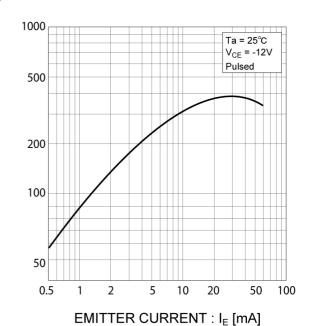


Fig.8 Gain Bandwidth Product vs.
Emitter Current



# ● Electrical characteristic curves(T<sub>a</sub> = 25°C)

Fig.9 Emitter Input Capacitance vs.
Emitter-Base Voltage
Collector Output Capacitance vs.
Collector-Base Voltage

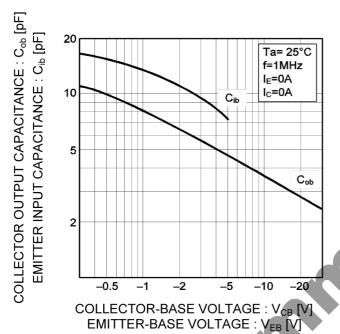
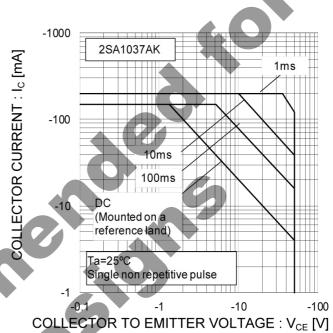
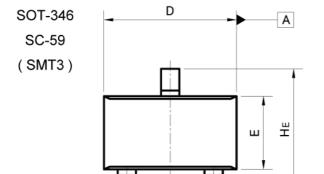


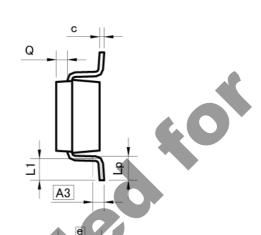
Fig.10 Safe Operating Area

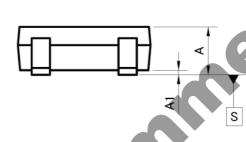




## Dimensions









Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
A	1.00	1.30	0.039	0.051	
(A1	0.00	0.10	0.000	0.004	
A3	0	25	0.010		
b	0.35	0.50	0.014	0.020	
С	0.09	0.25	0.004	0.010	
D	2.80	3.00	0.110	0.118	
E	1.50	1.80	0.059	0.071	
е	e 0.9		0.037		
HE	2.60	3.00	0.102	0.118	
L1	0.30	0.60	0.012	0.024	
Lp	0.40	0.70	0.016	0.028	
Q	0.20	0.30	0.008	0.012	
х	-	0.10	-	0.004	
У	- x	0.10	0 <del></del>	0.004	

xM S A

DIM	MILIM	ETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
b2		0.60	-	0.024	
e1	2.10		0.0	83	
- 11	-7	0.90	-	0.035	

Dimension in mm/inches



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(Note1) Medical Equipment Classification of the Specific Applications

(1 toto 1) modical Equipment Glacomeducit of the operation inplications						
JAPAN	USA	EU	CHINA			
CLASSⅢ	CL ACCIII	CLASS II b	CL A C C TT			
CLASSIV	CLASSⅢ	CLASSⅢ	CLASSⅢ			

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  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S. NH<sub>3</sub>. SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
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- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

## **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including CI2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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QR code printed on ROHM Products label is for ROHM's internal use only.

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When disposing Products please dispose them properly using an authorized industry waste company.

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